Feature

- Input voltage range: 4.75V to 24V
- Variable output voltage range: 1.222V to 20V
- 3A output current
- Efficiency up to 91%
- Fixed 380kHz operating frequency
- 20μA shutdown current
- Internal power MOSFET switch
- Stable operation using low ESR ceramic capacitors
- Over temperature protection
- Cycle-by-cycle over current protection
- Soft-start function
- Under voltage lockout protection
- 8-pin SOP package

General Description

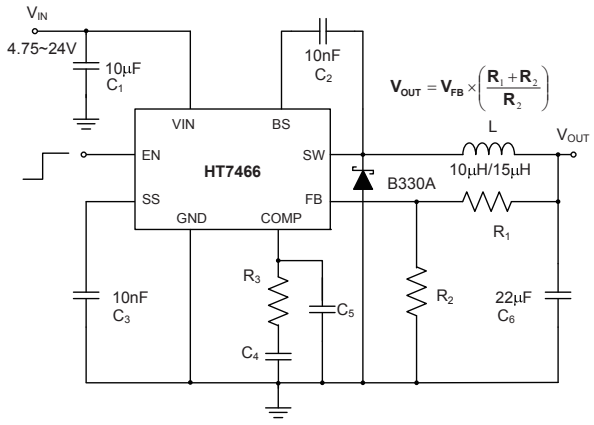
The HT7466 is a DC-DC buck regulator. The built-in high driver NMOS provides a monolithic solution for high efficiency step-down DC-DC converter. With 3A output current, the wide input voltage range and stable output voltage regulation can widely use in all kinds of application, like communication, power for high power LED, battery charger, etc. The protection function include over current and over temperature protection. The soft start function prevent inrush supply current and output overshoot when initial startup. The under voltage lockout is set to 4.1V. It prevents abnormal situation occurring.

The HT7466 requires a minimum number of standard external components and is available in a 8-pin SOP package for small area PCB application.

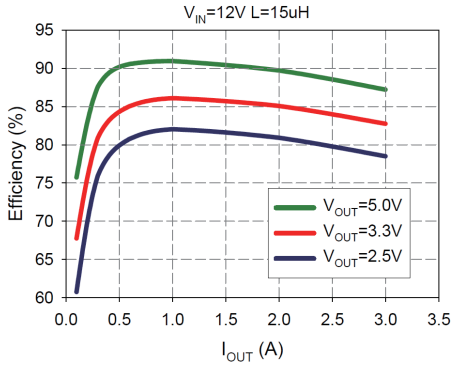
Applications

- Battery chargers
- Distributed power systems
- LED power supplies
- DSL modems
- Linear regulator pre power processing
- Set-Top-Boxes, DVD players, LCD displays

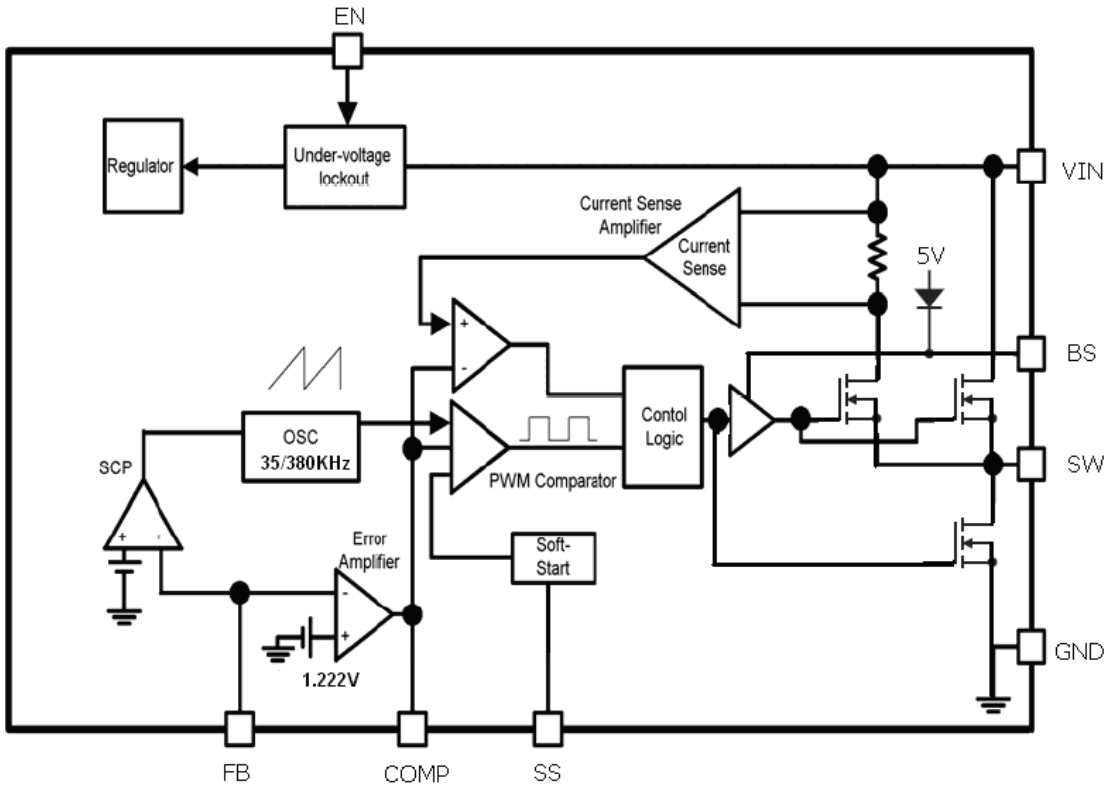
Application Circuit



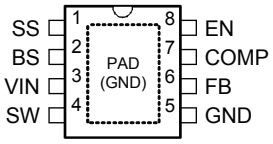
Efficiency vs Output Current



Block Diagram



Pin Assignment



HT7466
8 SOP-A
(Exposed Pad)

Pin Description

Pin No.	Pin Name	Description
1	SS	Soft-start input. If the soft start function is to be used then an external capacitor should be connected between this pin and ground. If the soft start function is not required the pin should be left open.
2	BS	Internal power NMOS gate drive boost input. A 10nF or greater value capacitor should be connected from SW to BS for additional Power NMOS gate driving purposes.
3	VIN	Power supply input. The input supply pin for the device, VIN, is connected to a supply voltage between 4.75V to 24V.
4	SW	Power switching output. The internal power MOS drain is connected to the inductor, diode and VIN.
5	GND	Ground. Device ground voltage reference.
6	FB	Feedback pin. The feedback pin is connected to an external resistor divider to measure the output voltage.
7	COMP	Error amplifier output. Used for compensation of the regulation control loop. Connect a series RC network from COMP to GND to compensate the regulation control loop. The COMP pin value is 1.222V.
8	EN	Enable input. This pin is set high to turn on the regulator and low to turn it off. The pin should be left unconnected if not used.
Exposed Pad	GND	Ground. Device ground voltage reference.

Absolute Maximum Ratings

Maximum Input Supply Voltage 26V
Switch Node Voltage 26V
Feedback Voltage 6V
EN Voltage 6V
Comp Voltage 6V
SS Voltage 6V
Maximum Junction Temperature ..... 150°C

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

Recommended Operating Conditions

Input Supply Voltage ..... 4.75V ~ 24V
Ambient Temperature Range ..... -40°C ~ +85°C

Electrical Characteristics

V_{IN}=12V, Ta=25°C, unless otherwise specified refer to circuit of Figure 1. (note 1)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
V_{FB}	Feedback Voltage	4.75V ≤ V_{IN} ≤ 24V	1.194	1.222	1.250	V
V_{UVLO}	Under Voltage Lockout Threshold	—	—	4.1	—	V
—	Under Voltage Lockout Threshold Hysteresis	—	—	200	—	mV
I_Q	Quiescent Current	V_{FB}=1.5V, V_{EN}=High	—	1.0	1.2	mA
I_{SS}	Shutdown Supply Current	V_{EN}=0V	—	20	30	μA
F_{OSC}	Oscillator Frequency	—	—	380	—	kHz
—	Short Circuit Frequency	V_{FB}=0V	20	35	50	kHz
D_{MAX}	Maximum Duty Cycle	V_{FB}=1.0V	—	90	—	%
I_{SW}	Upper Switch Leakage	V_{EN}=0V, V_{SW}=0V	—	0	10	μA
R_{DS}	Switch On Resistance (note 2)	I_{OUT}=3A	—	95	—	mΩ
I_{LIMIT}	Current Limit	—	—	4.3	—	A
—	Error Amplifier Voltage Gain (note 2)	—	—	70	—	dB
—	Error Amplifier Trans-conductance (note 2)	—	—	800	—	μA/V
V_{EN}	Enable Threshold	4.75V ≤ V_{IN} ≤ 24V	0.9	1.0	1.5	V
T_J	Thermal Shutdown	—	—	150	—	°C

Note: 1. Specifications are production tested at Ta=room temperature. Specifications over the -40°C to 85°C operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).

2. Designer test specifications.

Functional Description

Setting the Output Voltage

The HT7466 is a step down switching DC/DC converter device. The device switching output, SW, is connected to a standard converter LC filter circuit for buck conversion. The output current is sensed using an external voltage divider network connected to the load output voltage and ground, and the sense voltage feedback to the device on the FB pin. By comparing this sense voltage with an internally generated 1.222 voltage reference, suitable regulation can be implemented to achieve the required output voltage. By selecting suitable values of external voltage divider resistors, the desired output voltage can be adjusted to the required level. The output voltage can be calculated using the following formula:

$$V_{OUT} = \frac{R_1 + R_2}{R_2} \times 1.222$$

Where R2 is the resistor divider lower resistor and R1 is the upper resistor, and the R1, R2 must be kΩ level.

Compensation Components

Care must be taken when selecting external components. The COMP pin is the output of the error amplifier and must be properly connected to an external RC network to ensure regulator loop stability. The values of the compensation components given in Table 1 yield a stable control loop for the output voltage and capacitor given.

Table 1 Compensation Values for Typical Output Voltage/Capacitor Combinations.

V_{OUT}	L	R3	C4	R1	R2	C6	C5
2.5V	10μH/ 15μH	3.9kΩ	5.6nF	10.5kΩ	10kΩ	22μF Ceramic	—
3.3V	10μH/ 15μH	4.7kΩ	4.7nF	17.0kΩ	10kΩ	22μF Ceramic	—
5.0V	10μH/ 15μH	7.5kΩ	2.7nF	30.9kΩ	10kΩ	22μF Ceramic	—

Bootstrap Circuit

In this device bootstrap capacitor is connected from SW to BS pin, the Step-Down converter is use N-Channel MOSFET, and MOS source pin is floating to ground, this drive circuit of the application is called high-side circuit, and the drive circuit used in this kind of situation is called bootstrap circuit. Large capacitor values can keep internal high-side N-Channel MOSFET gate voltage greater than zero when power MOS is turn on; usually a 10nF capacitor is sufficient for most applications.

Current Limit Protection

The device has a cycle-by-cycle current limit to protect the internal power MOSFET. If the inductor current reaches the current limit threshold of 4.3A, the MOSFET oscillator frequency will be transformed from 380kHz to a short circuit frequency of 35kHz and the output current will remain at its current limit value.

Over Temperature Protection

A thermal shutdown is implemented to prevent damage due to excessive heat and power dissipation. Typically the thermal shutdown threshold is 150°C. The thermal shutdown is triggered the device stops switching and when the device thermal falls until the temperature hysteresis windows the device will be starts switching again.

Application Information

Inductor

The inductor is required to supply a constant current to the output load while being driven by the switched input voltage. The choice of inductor affects steady state operation as well as transient behavior and loop stability. There are three important electrical parameters which need to be considered when choosing an inductor:

- The inductor value
- DCR - copper wire resistance
- The saturation current

Inductor choice is especially important as it is important to ensure the inductor does not saturate under its peak current conditions, the general rule of keeping the inductor current peak-to-peak ripple approximately 30% of the nominal output current. Using this value of ripple current is a good compromise between excessive output voltage ripple and excessive component size and cost. Also ensure that the inductor has a low DCR to minimize power losses.

Input/Output Capacitor

Input Capacitor

Because the Vin pin is connected to the internal power MOSFET, when the power MOSFET is switching and the input current is discontinuous, therefore an input capacitor C1 (in PCB layout C1 and C8 is parallels input capacitor) is required to supply the AC current to the step-down converter while maintaining the DC input voltage. A low ESR ceramic capacitor is required to keep noise to a minimum.

Output Capacitor

The output capacitor is required to maintain the DC output voltage. Ceramic or low ESR electrolytic capacitors is the rule to choice of external load capacitor is also critical and low ESR value capacitors must be used to ensure stability. This capacitor must be connected very close to the inductor, with short traces for good noise performance.

Schottky Diode

The output diode conducts when the internal power MOSFET is switched off. There are three important electrical parameters to consider when choosing the diode:

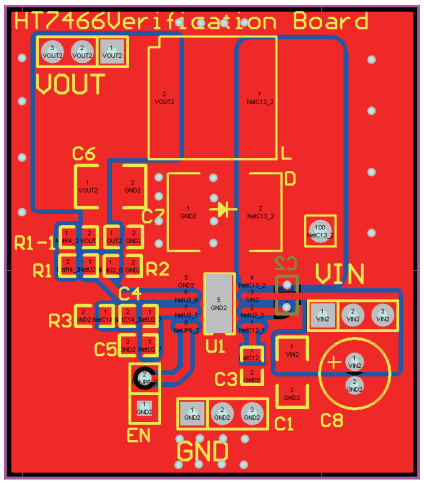
- The diode maximum reverse voltage value must be greater than the maximum input voltage.
- Short recovery time and low forward voltage -- use a schottky diode type.
- Diode current rating should be greater than the maximum load current.

Layout Considerations

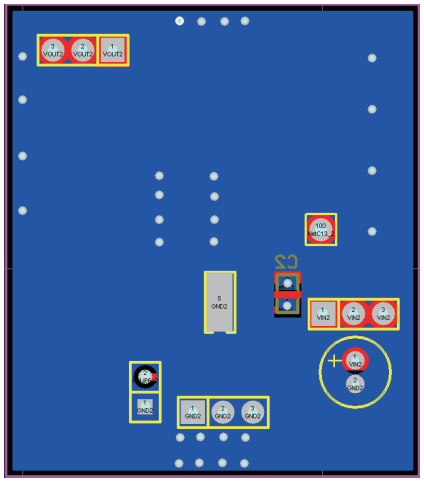
Circuit board layout is a very important consideration for switching regulators if they are to function properly. Poor circuit layout may result in related noise problems. In order to minimise EMI and switching noise, follow the guidelines below:

- All tracks should be as wide as possible.
- The input and output capacitors, C1 (C8) and C6 (C7), should be placed close to the VIN, VOUT and GND pins (C1 and C8 is parallel; C6 and C7 is parallel).
- The Schottky diode D and inductor L must be placed close to the SW pin.
- Feedback resistor, R1 (R1-1) and R2, must be placed close to the FB and GND pins (R1 and R1-1 is series).
- A full ground plane is always helpful for better EMI performance.

A recommended PCB layout with component locations is shown below.



Top Layer



Bottom Layer

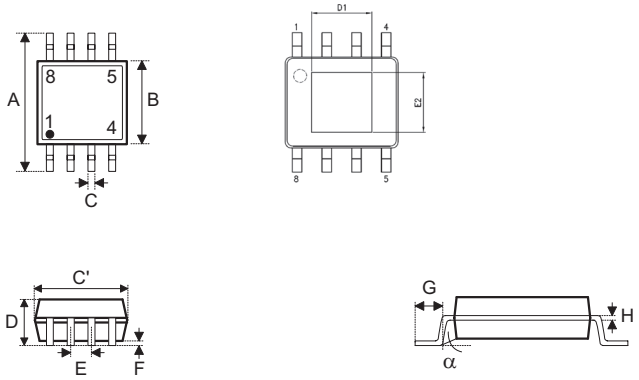
Package Information

Note that the package information provided here is for consultation purposes only. As this information may be updated at regular intervals users are reminded to consult the Holtek website for the latest version of the Package/Carton Information.

Additional supplementary information with regard to packaging is listed below. Click on the relevant section to be transferred to the relevant website page.

- Further Package Information (include Outline Dimensions, Product Tape and Reel Specifications)
- Packing Meterials Information
- Carton information

8-pin SOP_EP (150mil) Outline Dimensions for Thermally Enhanced Variations Only (Exposed Pad)



Symbol	Dimensions in inch		
	Min.	Nom.	Max.
A	—	0.236 BSC	—
B	—	0.154 BSC	—
C	0.012	—	0.020
C'	—	0.193 BSC	—
D	—	—	0.069
D1	0.059	—	—
E	—	0.050 BSC	—
E2	0.039	—	—
F	0.004	—	0.010
G	0.016	—	0.050
H	0.004	—	0.010
α	0°	—	8°

Symbol	Dimensions in mm		
	Min.	Nom.	Max.
A	—	6.00 BSC	—
B	—	3.90 BSC	—
C	0.31	—	0.51
C'	—	4.90 BSC	—
D	—	—	1.75
D1	1.50	—	—
E	—	1.27 BSC	—
E2	1.00	—	—
F	0.10	—	0.25
G	0.40	—	1.27
H	0.10	—	0.25
α	0°	—	8°

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